## NSR0230M2T5G, NSVR0230M2T5G

## **Schottky Barrier Diode**

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

#### **Features**

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.325 V (max) @  $I_F = 10 \text{ mA}$
- Low Reverse Current
- AEC Qualified and PPAP Capable
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- This is a Pb-Free Device\*

#### **MAXIMUM RATINGS**

Symbol	Value	Unit
V <sub>R</sub>	30	Vdc
I <sub>F</sub>	200	mA
I <sub>FSM</sub>	1.0	А
	V <sub>R</sub>	V <sub>R</sub> 30  I <sub>F</sub> 200  I <sub>FSM</sub>

ESD Rating: Class 3B per Human Body Model Class C per Machine Model

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1)  T <sub>A</sub> = 25°C  Derate above 25°C	P <sub>D</sub>	167 2.0	mW mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	600	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +125	°C

1. FR-5 Minimum Pad.



### ON Semiconductor®

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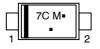
# 30 V SCHOTTKY BARRIER DIODE



SOD-723 CASE 509AA PLASTIC



#### **MARKING DIAGRAM**



7C = Specific Device Code

M = Month Code■ = Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping†
NSR0230M2T5G	SOD-723 (Pb-Free)	2 mm Pitch 8,000/Tape & Reel
NSVR0230M2T5G	SOD-723 (Pb-Free)	2 mm Pitch 8,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## NSR0230M2T5G, NSVR0230M2T5G

**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage $(V_R = 10 \text{ V})$ $(V_R = 30 \text{ V})$	I <sub>R</sub>	-		10 100	μΑ
Forward Voltage (I <sub>F</sub> = 10 mA) (I <sub>F</sub> = 200 mA)	V <sub>F</sub>	- -	-	0.325 0.500	Vdc

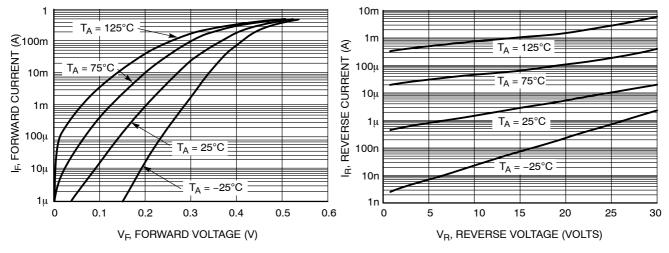


Figure 1. Forward Characteristics

Figure 2. Reverse Characteristics

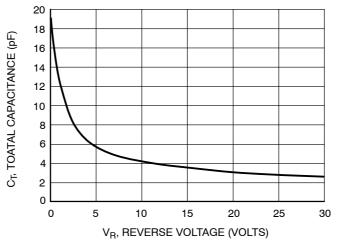


Figure 3. Total Capacitance





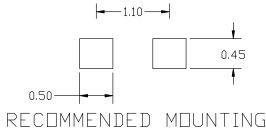
#### SOD-723, 2-LEAD, 1.00x0.60x0.52 CASE 509AA ISSUE A

**DATE 01 FEB 2024** 

#### NOTES:

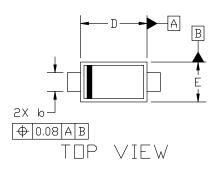
- 1. DIMENSIONSING AND TOLERANCING PER ASME Y14.5M, 2018.
- 2. CONTROLLING DIMENSIONS: MILLIMETER.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

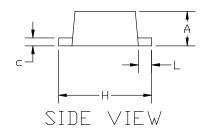
DIM	MILLIMETERS			
ואונע	MIN.	N□M.	MAX.	
А	0.49	0.52	0.55	
b	0.25	0.28	0.32	
C	0.08	0.12	0.15	
D	0.95	1.00	1.05	
E	0.55	0.60	0.65	
Н	1.35	1.40	1.45	
L	0.15	0.20	0.25	



\*For additional formation on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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# GENERIC MARKING DIAGRAM\*



XX = Specific Device Code M = Date Code

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DESCRIPTION:	SOD-723, 2-LEAD, 1.00x0.60x0.52		PAGE 1 OF 1	

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<sup>\*</sup>This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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